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## Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832
Email \& Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, \#122 Zhenhua RD., Futian, Shenzhen, China

## LOW DROP POWER SCHOTTKY RECTIFIER

MAIN PRODUCTS CHARACTERISTICS

| $\mathrm{I}_{\mathrm{F}(\mathrm{AV})}$ | 3 A |
| :---: | :---: |
| $\mathrm{~V}_{\text {RRM }}$ | 40 V |
| $\mathrm{~T}_{\mathrm{j}}$ | $150^{\circ} \mathrm{C}$ |
| $\mathrm{V}_{\mathrm{F}}(\max )$ | 0.475 V |

## FEATURES AND BENEFITS

- VERY SMALL CONDUCTION LOSSES
. NEGLIGIBLE SWITCHING LOSSES
. EXTREMELY FAST SWITCHING
. LOW FORWARD VOLTAGE DROP
. AVALANCHE CAPABILITY SPECIFIED


## DESCRIPTION

Axial Power Schottky rectifier suited for Switch Mode Power Supplies and high frequency DC to DC converters. Packaged in DO-201AD these devices are intended for use in low voltage, high frequency inverters, free wheeling, polarity protection and small battery chargers.


ABSOLUTE RATINGS (limiting values)

| Symbol | Parameter |  | Value |  |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | 1N5820 | 1N5821 | 1N5822 |  |
| VRRM | Repetitive peak reverse voltage |  | 20 | 30 | 40 | V |
| $\mathrm{I}_{\text {F(RMS })}$ | RMS forward current |  | 10 |  |  | A |
| $\mathrm{If}_{\text {(AV) }}$ | Average forward current | $\mathrm{T}_{\mathrm{L}}=100^{\circ} \mathrm{C} \quad \delta=0.5$ |  |  | 3 | A |
|  |  | $\mathrm{T}_{\mathrm{L}}=110^{\circ} \mathrm{C} \quad \delta=0.5$ | 3 | 3 |  | A |
| IFSM | Surge non repetitive forward current | $\begin{aligned} & \mathrm{tp}=10 \mathrm{~ms} \\ & \text { Sinusoidal } \end{aligned}$ | 80 |  |  | A |
| Parm | Repetitive peak avalanche power | $\mathrm{tp}=1 \mu \mathrm{~s} \quad \mathrm{Tj}=25^{\circ} \mathrm{C}$ |  | 1700 |  | W |
| $\mathrm{T}_{\text {stg }}$ | Storage temperature range |  |  | 65 to + 15 |  | ${ }^{\circ} \mathrm{C}$ |
| Tj | Maximum operating junction temperature * |  |  | 150 |  | ${ }^{\circ} \mathrm{C}$ |
| dV/dt | Critical rate of rise of reverse voltage |  |  | 10000 |  | $\mathrm{V} / \mathrm{\mu s}$ |

* : $\frac{d P t o t}{d T j}<\frac{1}{R t h(j-a)}$ thermal runaway condition for a diode on its own heatsink

1N582x

THERMAL RESISTANCES

| Symbol | Parameter |  | Value | Unit |
| :---: | :--- | :--- | :---: | :---: |
| $R_{\text {th }(j-a)}$ | Junction to ambient | Lead length $=10 \mathrm{~mm}$ | 80 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |
| $R_{\text {th }}(j-1)$ | Junction to lead | Lead length $=10 \mathrm{~mm}$ | 25 | ${ }^{\circ} \mathrm{C} / \mathrm{W}$ |

## STATIC ELECTRICAL CHARACTERISTICS

| Symbol | Parameter | Tests Conditions |  | 1N5820 | 1N5821 | 1N5822 | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $\mathrm{IR}^{\text {* }}$ | Reverse leakage current | $\mathrm{Tj}=25^{\circ} \mathrm{C}$ | $V_{R}=V_{\text {RRM }}$ | 2 | 2 | 2 | mA |
|  |  | $\mathrm{Tj}=100^{\circ} \mathrm{C}$ |  | 20 | 20 | 20 | mA |
| $\mathrm{V}_{\mathrm{F}}$ * | Forward voltage drop | $\mathrm{Tj}=25^{\circ} \mathrm{C}$ | $\mathrm{I}_{\mathrm{F}}=3 \mathrm{~A}$ | 0.475 | 0.5 | 0.525 | V |
|  |  | $\mathrm{Tj}=25^{\circ} \mathrm{C}$ | $\mathrm{I}_{\mathrm{F}}=9.4 \mathrm{~A}$ | 0.85 | 0.9 | 0.95 | V |

Pulse test: *tp $=380 \mu \mathrm{~s}, \delta<2 \%$
To evaluate the conduction losses use the following equations :
$\left.\mathrm{P}=0.33 \times \mathrm{IF}_{\mathrm{F}} \mathrm{AV}\right)+0.035 \mathrm{IF}_{2}^{2}$ (RMS) for $1 \mathrm{~N} 5820 / 1 \mathrm{~N} 5821$
$\mathrm{P}=0.33 \times \mathrm{I}_{\mathrm{F}(\mathrm{AV})}+0.060 \mathrm{I}_{\mathrm{F}}^{2}(\mathrm{RMS})$ for 1 N 5822

Fig. 1: Average forward power dissipation versus average forward current (1N5820/1N5821).


Fig. 3: Normalized avalanche power derating versus pulse duration.


Fig. 2: Average forward power dissipation versus average forward current (1N5822).


Fig. 4: Normalized avalanche power derating versus junction temperature.


Fig. 5-1: Average forward current versus ambient temperature ( $\delta=0.5$ ) (1N5820/1N5821).

IF(av)(A)


Fig. 6-1: Non repetitive surge peak forward current versus overload duration (maximum values) (1N5820/1N5821).


Fig. 7: Relative variation of thermal impedance junction to ambient versus pulse duration (epoxy printed circuit board, e(Cu) $=35 \mathrm{~mm}$, recommended pad layout).


Fig. 5-2: Average forward current versus ambient temperature ( $\delta=0.5$ ) ( 1 N 5822 ).


Fig. 6-2: Non repetitive surge peak forward current versus overload duration (maximum values) (1N5822).


Fig. 8: Junction capacitance versus reverse voltage applied (typical values).


Fig. 9-1: Reverse leakage current versus reverse voltage applied (typical values) (1N5820/1N5821).


Fig. 10-1: Forward voltage drop versus forward current (typical values) (1N5820/1N5821).


Fig. 9-2: Reverse leakage current versus reverse voltage applied (typical values) (1N5822).


Fig. 10-2: Forward voltage drop versus forward current (typical values) (1N5822).


Fig. 11: Non repetitive surge peak forward current versus number of cycles.


## PACKAGE MECHANICAL DATA

DO-201AD plastic


| REF. | DIMENSIONS |  |  |  | NOTES |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | Millimeters |  | Inches |  |  |
|  | Min. | Max. | Min. | Max. |  |
| A |  | 9.50 |  | 0.374 | 1 - The lead diameter $\wedge D$ is not controlled over zone $E$ <br> 2 - The minimum axial length within which the device may be placed with its leads bent at right angles is 0.59 " 15 mm ) |
| B | 25.40 |  | 1.000 |  |  |
| $\wedge$ - ${ }^{\text {c }}$ |  | 5.30 |  | 0.209 |  |
| $\wedge$, |  | 1.30 |  | 0.051 |  |
| E |  | 1.25 |  | 0.049 |  |


| Ordering type | Marking | Package | Weight | Base qty | Delivery mode |
| :---: | :---: | :---: | :---: | :---: | :---: |
| 1N582x | Part number <br> cathode ring | DO-201AD | 1.12 g | 600 | Ammopack |
| 1N582xRL | Part number <br> cathode ring | DO-201AD | 1.12 g | 1900 | Tape \& reel |

. EPOXY MEETS UL94,V0

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